

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

NXP Semiconductors/Freescale Semiconductor, Inc. PESD5V0X2UAMBYL

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



Distributor of NXP Semiconductors/Freescale Semiconductor, Inc. : Excellent Integrated Datasheet of PESD5V0X2UAMBYL - TVS DIODE 5VWM 14VC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

10 April 2014

Product data sheet

1. General description

Ultra low capacitance unidirectional double ElectroStatic Discharge (ESD) protection diode in a DFN1006B-3 (SOT883B) leadless ultra small Surface-Mounted Device (SMD) plastic package designed to protect up to two signal lines from the damage caused by ESD and other transients.

2. Features and benefits

- Ultra low diode capacitance: C_d = 0.8 pF
- Ultra low package height of only 0.37 mm
- ESD protection up to 15 kV; IEC61000-4-2
- I_{PPM} = 2.5 A; IEC 61643-321 (surge)
- AEC-Q101 qualified

3. Applications

- High-speed data lines
- Portable electronics
- Communication systems
- Computers and peripherals

4. Quick reference data

Table 1. Quick reference data								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Per diode							-	
C _d	diode capacitance	f = 1 MHz; V _R = 0 V	[1]	-	0.8	0.95	pF	
V _{RWM}	reverse standoff voltage			-	-	5	V	

[1] Measured from pin 1 or 2 to 3.







PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	1	1-[4]
2	K2	cathode (diode 2)	2	
3	A	common anode	Transparent top view DFN1006B-3 (SOT883B)	brb051

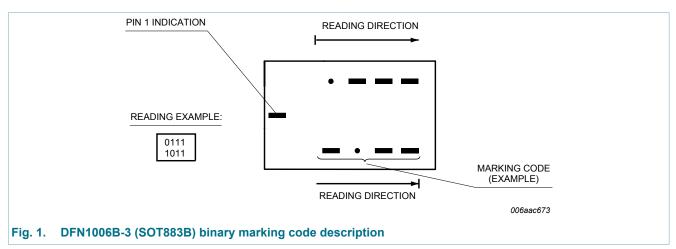
6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PESD5V0X2UAMB	DFN1006B-3	DFN1006B-3: leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm	SOT883B			

7. Marking

Table 4. Marking codes

Type number	Marking code
PESD5V0X2UAMB	0100 1111



PESD5V0X2UAMB



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

8. Limiting values

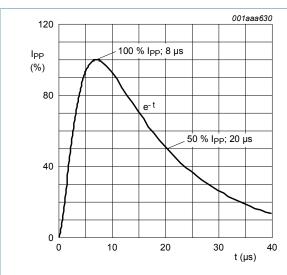
Table 5. Limiting values

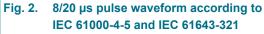
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode		·		-		
I _{PPM}	rated peak pulse current	t _p = 8/20 μs	[1][2]	-	2.5	А
Tj	junction temperature			-	150	°C
T _{stg}	storage temperature			-55	150	°C
T _{amb}	ambient temperature			-65	150	°C
ESD maxim	num ratings	1				
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[3][2]</u>	-	15	kV
		IEC 61000-4-2 (air discharge)	[3][2]	-	15	kV
		machine model	[2]	-	400	V
		MIL-STD-883 (human body model)		-	10	kV

[1] According to IEC 61000-4-5 and IEC 61643-321.

- [2] Measured from pin 1 or 2 to 3.
- [3] Device stressed with ten non-repetitive ESD pulses.





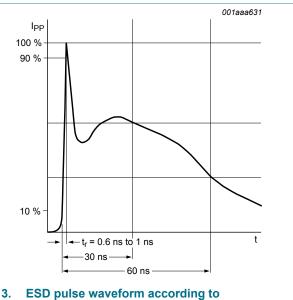


Fig. 3. ESD pulse waveform according t IEC 61000-4-2

PESD5V0X2UAMB



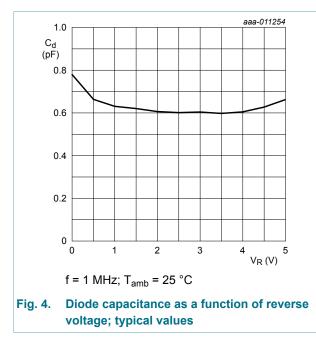
PESD5V0X2UAMB

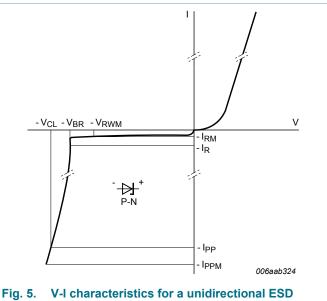
Ultra low capacitance unidirectional double ESD protection diode

Characteristics 9.

Table 6. (Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode				-			
V _{RWM}	reverse standoff voltage			-	-	5	V
I _{RM}	reverse leakage current	V _R = 5 V	[1]	-	1	10	nA
V _{CL}	clamping voltage	I _{PP} = 1 A; t _p = 8/20 μs	[<u>2][1]</u>	-	-	13	V
		I _{PP} = 2.5 A; t _p = 8/20 μs	[2][1]	-	-	14	V
V _{BR}	breakdown voltage	I _R = 10 mA	[1]	7.5	8.8	10	V
C _d	diode capacitance	f = 1 MHz; V _R = 0 V	[1]	-	0.8	0.95	pF
R _{dyn}	dynamic resistance	I _R = 10 A	[3][1]	-	0.65	-	Ω

- Measured from pin 1 or 2 to 3. [1]
- [2] According to IEC 61000-4-5 and IEC 61643-321.
- Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008. [3]



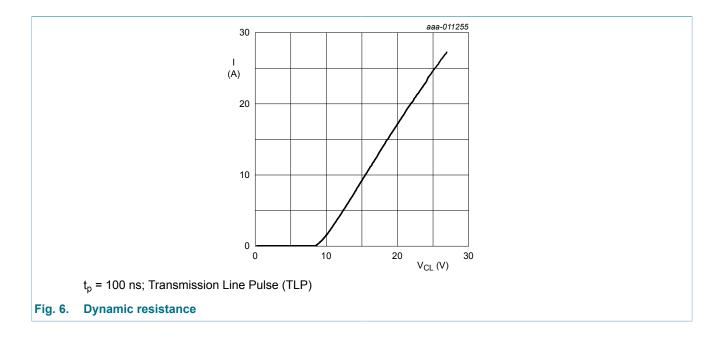


protection diode



PESD5V0X2UAMB

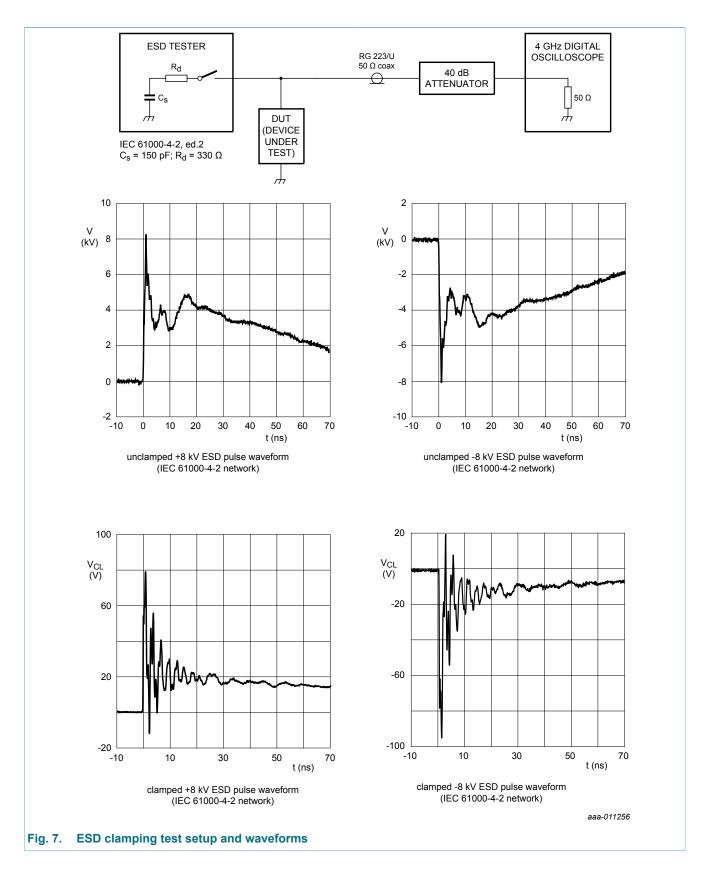
Ultra low capacitance unidirectional double ESD protection diode





PESD5V0X2UAMB





Product data sheet



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

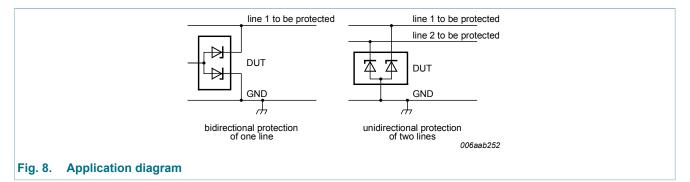
10. Test information

10.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

11. Application information

The device is designed for the protection of up to two unidirectional data lines from surge pulses and ESD damage.



Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. Minimize the path length between the device and the protected line.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

12. Package outline

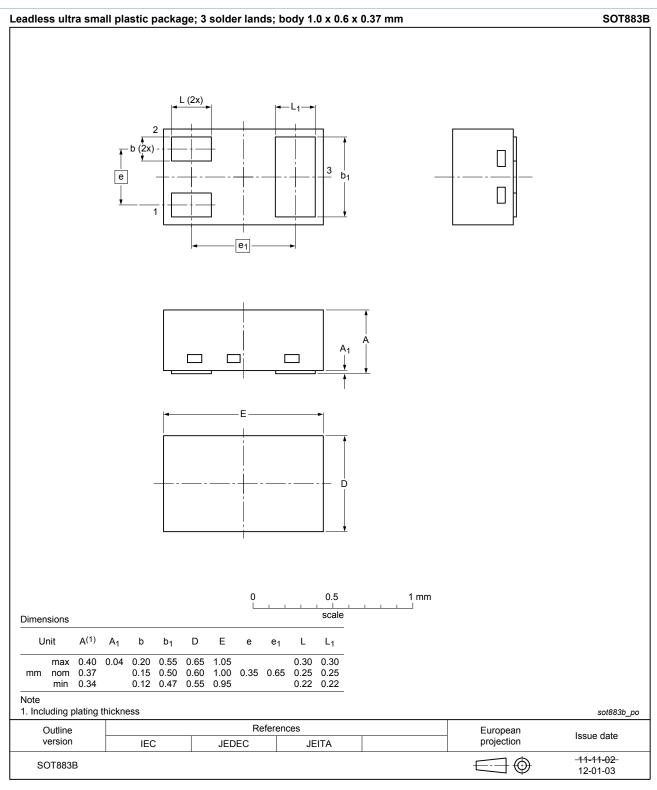


Fig. 9. Package outline DFN1006B-3 (SOT883B)

PESD5V0X2UAMB

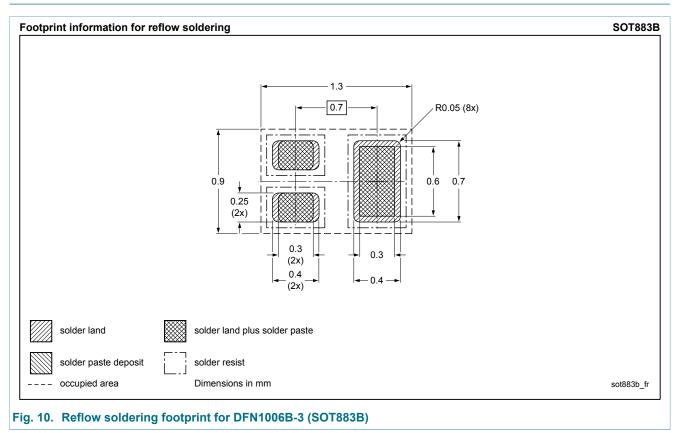
Product data sheet



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

13. Soldering





PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

14. Revision history

Table 7. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PESD5V0X2UAMB v.1	20140410	Product data sheet	-	-		

PESD5V0X2UAMB

10/13



Distributor of NXP Semiconductors/Freescale Semiconductor, Inc. : Excellent Integrated S Datasheet of PESD5V0X2UAMBYL - TVS DIODE 5VWM 14VC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NXP Semiconductors

PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nxp.com</u>.

15.2 Definitions

Preview — The document is a preview version only. The document is still subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This NXP Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

PESD5V0X2UAMB

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2014. All rights reserved



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

No offer to sell or license - Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners

Adelante, Bitport, Bitsound, CoolFlux, CoReUse, DESFire, EZ-HV, FabKey, GreenChip, HiPerSmart, HITAG, I²C-bus logo, ICODE, I-CODE, ITEC, Labelution, MIFARE, MIFARE Plus, MIFARE Ultralight, MoReUse, QLPAK, Silicon Tuner, SiliconMAX, SmartXA, STARplug, TOPFET, TrenchMOS, TriMedia and UCODE - are trademarks of NXP Semiconductors N.V.

HD Radio and HD Radio logo - are trademarks of iBiquity Digital Corporation.

PESD5V0X2UAMB

12/13



PESD5V0X2UAMB

Ultra low capacitance unidirectional double ESD protection diode

16. Contents

General description1	l
Features and benefits	1
Applications 1	
Quick reference data	1
Pinning information2	2
Ordering information2	2
Marking2	2
Limiting values	3
Characteristics4	ł
Test information7	7
Quality information7	7
Application information7	7
Package outline	
Soldering9)
Revision history10)
Legal information11	I
Data sheet status1	1
Definitions11	
Disclaimers11	
Trademarks 12	2
	Features and benefits 1 Applications 1 Quick reference data 1 Pinning information 2 Ordering information 2 Limiting values 3 Characteristics 4 Test information 7 Quality information 7 Application information 7 Package outline 8 Soldering 9 Revision history 10 Legal information 11 Definitions 11

© NXP Semiconductors N.V. 2014. All rights reserved

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com Date of release: 10 April 2014

Product data sheet

13/13